Chip resistor networks MNR02 (1005 × 2 size)

Features

1) Extremely small and light

Area ratio is 60% smaller than that of chip 1616 (MNR12), while weight ratio has been cut 75%.

2) High-density mounting

Can be mounted even more densely than two 1005 chips (MCR01). Also, the cost of mounting has been reduced.

- 3) Compatible with a wide range of mounting equipment.
 - Squared corners make it excellent for mounting using image recognition devices.
- 4) Convex electrodes

Easy to check the fillet after soldering is finished.

5) ROHM resistors have obtained ISO-9001 certification.

Design and specifications are subject to change without notice. Carefully check the specification sheet before using or ordering it.

Ratings

Item	Conditions	Specifications
Rated power	Power must be derated according to the power derating curve in Figure 1 when ambient temperature exceeds 70°C. 100 100 100 100 100 100 100 100 100 1	0.063W (1 / 16W) at 70°C
Rated voltage	The voltage rating is calculated by the following equation. If the value obtained exceeds the limiting element voltage, the voltage rating is equal to the maximum operating voltage. $E : Rated \ voltage \ (V)$ $E = \sqrt{P \times R} \qquad P : Rated \ power \ (W)$ $R : Nominal \ resistance \ (\Omega)$	Limiting element voltage 25V
Nominal resistance	See <u>Table 1</u> .	
Operating temperature		–55°C to +125°C



Table 1

Resistance tolerance	Resistance range (Ω)	Resistance temperature coefficient (ppm / °C)
J (±5%)	10≤R≤1M (E24)	±300

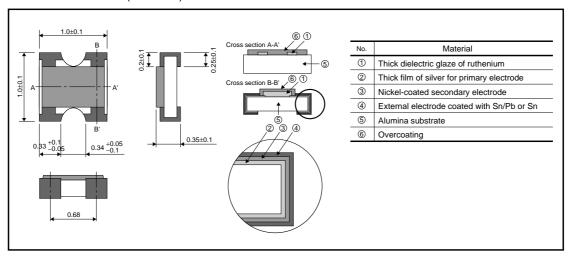
[•]Before using components in circuits where they will be exposed to transients such as pulse loads (short-duration, high-level loads), be certain to evaluate the component in the mounted state. In addition, the reliability and performance of this component cannot be guaranteed if it is used with a steady state voltage that is greater than its rated voltage.

Characteristics

Items	Guaranteed value	Test conditions (JIS C 5201-1)	
items	Resistor type	rest conditions (313 C 3201-1)	
Resistance	J:±5%	JIS C 5201-1 4.5	
Variation of resistance with temperature	See <u>Table.1</u>	JIS C 5201-1 4.8 Measurement : -55 / +25 / +125°C	
Overload	± (2.0%+0.1Ω)	JIS C 5201-1 4.13 Rated voltage (current) ×2.5, 2s. Limiting Element Voltage×2 : 50V	
Solderability	A new uniform coating of minimum of 95% of the surface being immersed and no soldering damage.	JIS C 5201-1 4.17 Rosin-Ethanol (25%WT) Soldering condition : 235±5°C Duration of immersion : 2.0±0.5s.	
Resistance to soldering heat	$\label{eq:total_problem} \pm (1.0\% + 0.05\Omega)$ No remarkable abnormality on the appearance.	JIS C 5201-1 4.18 Soldering condition : 260±5°C Duration of immersion : 10±1s.	
Rapid change of temperature	± (1.0%+0.05Ω)	JIS C 5201-1 4.19 Test temp. : –55°C~+125°C 5cyc	
Damp heat, steady state	± (3.0%+0.1Ω)	JIS C 5201-1 4.24 40°C, 93%RH Test time : 1,000h~1,048h	
Endurance at 70°C	± (3.0%+0.1Ω)	JIS C 5201-1 4.25.1 Rated voltage (current), 70°C 1.5h : ON – 0.5h : OFF Test time : 1,000h~1,048h	
Endurance	± (3.0%+0.1Ω)	JIS C 5201-1 4.25.3 125°C Test time : 1,000h~1,048h	
Resistance to solvent	± (1.0%+0.05Ω)	JIS C 5201-1 4.29 23±5°C, Immersion cleaning, 5±0.5min Solvent : 2-propanol	
Bend strength of the end face plating	\pm (1.0%+0.05 Ω) Without mechanical damage such as breaks.	JIS C 5201-1 4.33	

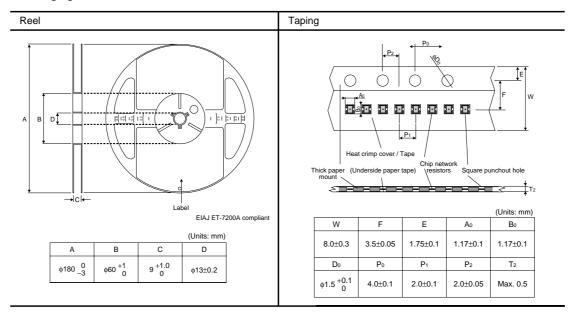


●External dimensions (Units: mm)

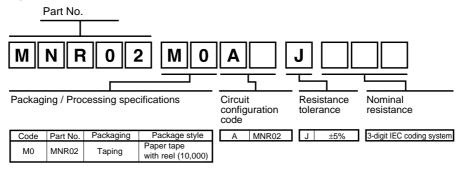


●Equivalent circuit

Packaging



Product designation



Electrical characteristics

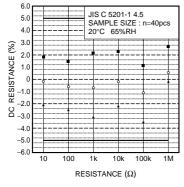


Fig.2 Resistance

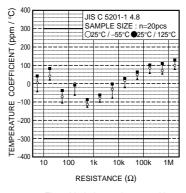


Fig.3 Variation resistance with temperature

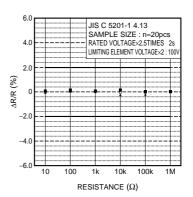


Fig.4 Overload

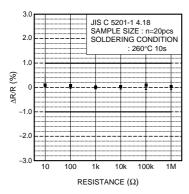


Fig.5 Resistance to soldering heat

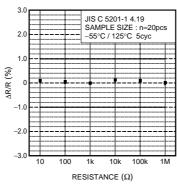


Fig.6 Rapid change of temperature

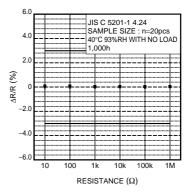


Fig.7 Damp heat, steady state

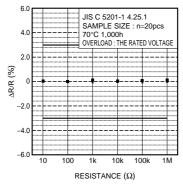


Fig.8 Endurance at 70°C

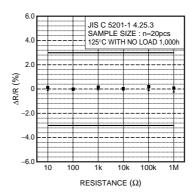


Fig.9 Endurance